

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

PATENT NO. : 6,982,210 B2
DATED : January 3, 2006
INVENTOR(S) : Ghyselen et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

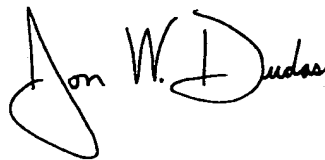
Column 8,

Line 14, after "interface with the donor substrate and having", change "a" to -- an --.

Line 55, after "the wafer to an appropriate", change "beat" to -- heat --.

Signed and Sealed this

Seventh Day of March, 2006

A handwritten signature in black ink, appearing to read "Jon W. Dudas". The signature is stylized with a large, looping initial "J" and a distinct "D" at the end.

JON W. DUDAS
Director of the United States Patent and Trademark Office